## Antenna Switch Control

The MDC5101 inputs TxE and RxE Logic Signals with an accessory input termination option and, allows positive and negative control voltages in accordance with the enclosed truth table. This device is primarily intended to control GaAs RF switches. It is also designed to interface with most HCMOS MCUs such as the ON Semiconductor MC68338.

The MDC5101 is intended to replace a circuit of up to 18 discrete components and is available in a Micro-8 package. This device, in combination with a compatible RF switch, can be used to achieve duplex isolation in any Time Division Duplex Radio like GSM and DCS1800 with staggered Transmit Receive Time Slots. It can also be used to control an RF switch in dual band radio applications.

This integrated solution in a Micro-8 package compared with a discrete solution will add a great value in performance with less board space consumption.

## Features

- Miniature Micro-8 Surface Mount Package Saves Board Space
- Logic Level Control
- Designed to Interface with Microcontrollers


## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Positive Power Supply Voltage ${ }^{(1)}$ | $\mathrm{V}_{\mathrm{CC}}$ | 15 | Vdc |
| Negative Power Supply Voltage ${ }^{(2)}$ | $\mathrm{V}_{\mathrm{EE}}$ | -12 | Vdc |
| Differential Power Supply Voltage | $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}$ | 15 | Vdc |
| Input Voltage ${ }^{(3)}$ | $\mathrm{V}_{\text {in }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Vdc |
| Output Current ${ }^{(4)}$ | $\mathrm{I}_{1}, \mathrm{I}_{2}$ | 5.0 | mAdc |
| Operating Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Total Power Dissipation | $\mathrm{P}_{\mathrm{D}}$ | 510 | mW |
| Derate above $25^{\circ} \mathrm{C}$ |  | 4.0 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Thermal Resistance, Junction to Ambient | $\mathrm{R}_{\text {日JA }}$ | 245 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Note 1: Pin 1 Referenced to Ground
Note 2: Pin 6 Referenced to Ground
Note 3: Pin 3, 4 Referenced to Ground
Note 4: Pin 5, 7 Referenced to Ground

## DEVICE MARKING

| 5101 |  |
| :--- | :--- |
| ORDERING INFORMATION |  |
| MDC5101R2 | 13 inch Reel, 4000 units |

## ESD Rating

ESD protection on each pin to $\pm 2500 \mathrm{~V}$ per MIL-STD6883 method 3015 , using human body model of $100 \mathrm{pF}, 1500$ Ohms and using the machine model to $\pm 200 \mathrm{~V}$ at 100 pF and 0 Ohms. Parts must meet electrical requirement after testing.

ELECTRICAL CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{CC}}=2.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {low }}\right.$ to $\mathrm{T}_{\text {high }}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |

DC PARAMETERS

| Positive Power Supply Current <br> V1, V2, ACC $10 \mathrm{k} \Omega$ to $\mathrm{GND}, \mathrm{RxE}=\mathrm{V}_{\mathrm{IH}}, \mathrm{TxE}=\mathrm{V}_{\mathrm{IL}}$ | Icc | - | - | 1.0 | mA |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Negative Power Supply Current <br> V1, V2, ACC Open, RxE = $\mathrm{V}_{\mathrm{IL}}, \mathrm{TxE}=\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{I}_{\text {EE }}$ | - | -50 | - | $\mu \mathrm{A}$ |
| Negative Power Supply Current <br> V1, V2, ACC $10 \mathrm{k} \Omega$ to GND, RxE $=\mathrm{V}_{\mathrm{IL}}, \mathrm{TxE}=\mathrm{V}_{\mathrm{IH}}$ | $l_{\text {ee }}$ | -1.5 | - | - | mA |
| $\begin{aligned} & \text { High Level Output Voltage } \\ & I_{1}=I_{2}=250 \mu A, A C C \text { Open } \\ & R \times E=V_{I L}, T \times E=V_{I H} \\ & R \times E=V_{I H}, T x E=V_{I L} \\ & I_{1}=I_{2}=250 \mu A, A C C 10 \mathrm{k} \Omega \text { to GND } \\ & R \times E=V_{I L}, T \times E=V_{I H} \\ & R \times E=V_{\text {IH }}, T x E=V_{I L} \end{aligned}$ | $\mathrm{V}_{\mathrm{OH}(\mathrm{V} 1)}$ <br> $\mathrm{V}_{\mathrm{OH}(\mathrm{V} 2)}$ <br> $\mathrm{V}_{\mathrm{OH}(\mathrm{V} 2)}$ <br> $\mathrm{V}_{\mathrm{OH}\left(\mathrm{V}_{1}\right)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}^{-}-0.25} \\ & \mathrm{~V}_{\mathrm{IH}^{-}}-2.25 \\ & \mathrm{~V}_{\mathrm{IH}^{-}-0.25} \\ & \mathrm{~V}_{\mathrm{IH}^{-}}-0.25 \end{aligned}$ |  |  | Vdc |
| $\begin{aligned} & \text { Low Level Output Voltage } \\ & I_{1}=I_{2}=250 \mu A, A C C \text { Open } \\ & R x E=T x E=V_{I L} \\ & R x E=V_{I H}, T x E=V_{I L} \\ & I_{1}=I_{2}=250 \mu A, A C C 10 \mathrm{k} \Omega \text { to GND } \\ & R x E=T x E=V_{I L} \\ & R x E=V_{I H}, T x E=V_{I L} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{OL}(\mathrm{V} 1, \mathrm{~V} 2)}$ <br> VoL(V1) <br> $\mathrm{V}_{\mathrm{OL}(\mathrm{V} 1, \mathrm{~V} 2)}$ <br> $\mathrm{V}_{\mathrm{OL}(\mathrm{V} 2)}$ | $\begin{aligned} & -0.5 \\ & -0.5 \\ & \\ & -0.5 \\ & -0.5 \end{aligned}$ | 0 0 0 0 | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 0.5 \\ & 0.5 \end{aligned}$ | Vdc |
| Low Level Output Voltage $\begin{aligned} & \mathrm{I}_{1}=\mathrm{I}_{2}=250 \mu \mathrm{~A}, \mathrm{TxE}=\mathrm{V}_{\mathrm{IH}}, \mathrm{RxE}=\mathrm{V}_{\mathrm{IL}} \\ & \text { ACC Open } \\ & \text { ACC } 10 \mathrm{k} \Omega \text { to GND } \end{aligned}$ | $\mathrm{V}_{\mathrm{OL}(\mathrm{V} 2)}$ <br> $\mathrm{V}_{\mathrm{OL}(\mathrm{V} 1)}$ |  |  | $\begin{aligned} & -4.5 \\ & -4.5 \end{aligned}$ | Vdc |

AC PARAMETERS

| Propagation Delay |  |  |  |  | $\mu \mathrm{s}$ |
| :--- | :---: | :---: | :---: | :---: | :---: |
| RxE, TxE to V1, V2 | $\mathrm{t}_{\mathrm{PLH}}$ | - | - | 1.5 |  |
| ACC Open | $\mathrm{t}_{\text {PHL }}$ | - | - | 1.5 |  |
| RxE, TxE to V1, V2 | $\mathrm{t}_{\text {PLH }}$ | - | - | 1.5 |  |
| ACC $10 \mathrm{k} \Omega$ to GND | $\mathrm{t}_{\text {PHL }}$ | - | - | 1.5 |  |
| ACC to V1, V2 | $\mathrm{t}_{\mathrm{PLH}}$ | - | - | 5.0 |  |
|  | $\mathrm{t}_{\text {PHL }}$ | - | - | 5.0 |  |

## TRUTH TABLE

| Input Logic |  |  | Output Logic |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{R x E}$ | TxE | ACC | V2 | V1 |  |
| 0 | 0 | 0 | 0 | 0 |  |
| 0 | 0 | 1 | 0 | 0 |  |
| 0 | 1 | 0 | -5.0 | 2.7 |  |
| 0 | 1 | 1 | 2.7 | -5.0 |  |
| 1 | 0 | 0 | 2.7 | 0 |  |
| 1 | 0 | 1 | 0 | 2.7 |  |
|  | State not allowed in software |  |  |  |  |
| 1 | 1 | 0 | 2.7 | 2.7 |  |
| State not allowed in software |  |  |  |  |  |
| 1 | 1 | 1 | 2.7 | 2.7 |  |

Note: ACC Logic Low $=$ Open, ACC Logic High $=10 \mathrm{k} \Omega$

| Low Level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| RxE, TxE <br> High Level Input Voltage <br> RxE, TxE | $\mathrm{V}_{\mathrm{IH}}$ | - | - | 0.4 |  |
| Maximum Voltage Differential |  | 2.5 | - | - |  |



Figure 1. $\mathrm{V}_{\text {out (high) }}$ versus Temperature


Figure 3. I IcC versus Temperature


Figure 5. $\mathrm{I}_{\mathrm{EE}}$ versus Temperature


Figure 2. $\mathrm{V}_{\text {out (low) }}$ versus Temperature


Figure 4. $\mathrm{I}_{\mathrm{EE}}$ versus Temperature


Figure 6. $I_{E E}$ versus $V_{E E}$


Figure 7. $\mathrm{I}_{\mathrm{cc}}$ versus $\mathrm{V}_{\mathrm{Cc}}$


Figure 8. $\mathrm{V}_{\text {out }}$ versus $\mathrm{V}_{\mathrm{EE}}$


Figure 9. $\mathrm{V}_{\text {out }}$ versus $\mathrm{V}_{\mathrm{IH}} / \mathbf{V}_{\mathrm{CC}}$


Figure 10. Antenna Switch Controller Block Diagram


Figure 11. Temperature Measurement Schematic


Figure 12. Measurement Schematic $\mathrm{V}_{\text {out }}$ vs $\mathrm{V}_{\mathrm{EE}}$ \& $\mathrm{I}_{\mathrm{EE}}$ vs $\mathrm{V}_{\mathrm{EE}}$


Figure 13. Measurement Schematic
$\mathrm{V}_{\text {out }}$ vs $\mathrm{V}_{\mathrm{CC}}$

## MDC5101

## PACKAGE DIMENSIONS

## Micro8

CASE 846A-02
ISSUE E


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 ( 0.010 ) PER SIDE.

|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 2.90 | 3.10 | 0.114 | 0.122 |
| B | 2.90 | 3.10 | 0.114 | 0.122 |
| C | --- | 1.10 | --- | 0.043 |
| D | 0.25 | 0.40 | 0.010 | 0.016 |
| G | 0.65 BSC |  | 0.026 |  |
| BSC |  |  |  |  |
| H | 0.05 | 0.15 | 0.002 | 0.006 |
| J | 0.13 | 0.23 | 0.005 | 0.009 |
| K | 4.75 | 5.05 | 0.187 | 0.199 |
| L | 0.40 | 0.70 | 0.016 | 0.028 |

## MDC5101


#### Abstract

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